

Novel High Throughput-to-Area Efficiency and Strong-Resilience Datapath of AES for Lightweight Implementation in IoT Devices

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Abstract—A new datapath for the advanced encryption standard (AES) is proposed in this work, which is successfully optimized with a high efficiency of throughput-to-area for lightweight applications in Internet of Things (IoT) devices. The proposed AES architecture enables parallel encryption of 32-bit blocks for efficient processing of 128-bit data while minimizing hardware area. Optimization is achieved by utilizing shift registers instead of conventional registers in the ShiftRows, MixColumns, and key expansion stages of the 32-bit AES operation. Our implementation, based on the TSMC 40-nm process, achieves a throughput of 692.65 Mb/s, with a gate count of 5.65K and a figure of merit (FOM) of 122.59-Mb/s/k-gate, better than all the previous works in terms of efficiency. Furthermore, our proposed 32-bit datapath ensures security against correlation power analysis attacks owing to designed simultaneously active encryption and decryption, as the 32-bit key out of 128 bits remains unrevealed even with 100 000 traces for attack.

Index Terms—32-bit datapath, advanced encryption standard (AES), differential power analysis (DPA), high efficiency, lightweight, low area.

I. INTRODUCTION

CRYPTOGRAPHIC algorithms are designed and applied for the encryption and decryption of data communicated between devices and systems, which is particularly crucial for ensure the security of data transmission between Internet of Things (IoT) devices and the cloud. Well-designed cryptographic algorithms are expected to provide authentication, confidentiality, and data integrity for communications initiated by IoT devices. The performance of such crypto-algorithms is often evaluated by security strength and the execution speed when implemented in various hardware forms. There are a few crypto-algorithms being used now for data communication of

IoT devices. The most popular one is the advanced encryption standard (AES), which was published in 2001 by the national institute of standards and technology (NIST) [1]. The Rijndael algorithm was selected as the standard for AES. AES in fact replaced the older and weaker data encryption standard (DES) and has become the most widely used cryptographic algorithms used for data confidentiality during communication. To date, numerous circuit designs for implementing AES computations in hardware have been reported, all of which can be categorized into two groups for different ends, high throughput, or low cost by small chip area [2], [3].

One of the challenges in achieving the required security of AES is the limited hardware resources available in IoT devices for conducting required computations of encryption and decryption. Therefore, the hardware implementation of AES is expected to be more resource efficient, also known as “lightweight,” to be accommodated in the IoT edge device. On the other hand, there is a growing demand for AES encryption and decryption devices to achieve higher processing speeds to meet various application requirements. High-speed applications, such as network routers, require gigabit-per-second processing capabilities [3], while other devices, such as handheld or home devices, may only need to process data at the megabit-per-second level. However, due to the substantial computational complexity of AES, simultaneously reducing the operation time and circuit area of the designed AES is challenging. It is not an easy task to balance the throughput and hardware resource consumption while maintaining a positive user experience. Nonetheless, researchers continue to explore the possibility of elevating the throughput-to-area efficiency of AES. Even though the algorithm has been around for more than 20 years since 2001, ongoing efforts are valuable to enhance its performance, especially for IoT devices.

In recent years, efforts are dedicated by researchers to develop implementations of AES with a favorable balance between throughput and chip area. Satoh et al. [4] are the first to describe the compact high-speed hardware architecture and logic optimization method for the AES algorithm. This work combined the encryption and decryption datapaths and optimized the S-Box structure by introducing a new compound domain. Pramstaller et al. [5] proposed a compact AES co-processor that covers all key lengths (128, 192, and 256 bit) for encryption and decryption and supports cipher block chaining mode (CBC). Mathew et al. [6] achieved the process of performing encryption and decryption with minimal energy

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usage by optimizing the $GF(2^4)^2$ circuit to reduce the delay of the S-Box unit and using the folded data path design to reduce the wiring complexity of the ShiftRow arrangement. In subsequent years, several researchers [7], [8], [9], [10], [11] focus on minimizing the area to below 10k gate count. Wang and Ha [12] dedicated to achieving encryption computations within a single cycle to significantly boost throughput. Kouser et al. [13] and other works [14], [15], [16], [17], [18], [19], [20] were committed to enhancing throughput, achieving a maximum of 2457 Mb/s. Some research works, including Bui et al. [21] and others [22], [23], [24] managed to keep their power consumption below 0.8 pJ/bit by minimizing the active power in S-box, clock gating strategies, and data paths. Chong et al. [25] achieved the lowest power consumption of 0.23 pJ/bit. More recently, both Kundi et al. [26] and Ng et al. [27] have been seeking a balance between area and throughput. Notably, Kundi et al. [26] achieved the best experimental result with a figure of merit (FOM) of 106.18 Mb/s/k-gate, which is actually the ratio of the throughput divided by gate count.

The focus of this study is to achieve high throughput-to-area efficiency for varied lightweight implementations of IoT devices, while maintaining strong resilience to attacks. Toward this end, the *composite field algorithm* is employed herein to compute the S-box, while a *matrix multiplication method* for Mix/InvMix-Columns and *novel ShiftRow/Inverse-ShiftRow operation* are adopted, successfully minimizing the area to 5.65K gates, and increasing the throughput to 692.65 Mb/s. As a result, the FOM delivered by the proposed AES achieves as high as 122.59 Mb/s/k-gate, the *highest to date* compared to all the reported works. On top of the favorable efficiency achieved is the security evaluation on the proposed datapath conducted by this study. It is shown by experiments that thanks to the designed simultaneously active operations in forward and inverse datapaths during either encryption or decryption by the proposed novel AES architecture, the power attacks are successfully thwarted. This countermeasure design against power attacks employs a hiding strategy through asynchronous operation [28], [29]. This involves simultaneously executing encryption and decryption operations within the same cycle to hide the sensitive power leakage from the S-box. Experiments show the 32-bit key out of 128 bits remains secure against correlation power analysis attacks, which actually requires more than 100 000 traces for potential leakage, showing strong resilience offered by the designed AES.

The remainder of this article is organized as follows. Section II describes the proposed datapath architecture for AES, highlighting the optimizations employed. Section III presents the experimental results, including throughput, gate count, and the FOM, and discusses the security evaluation of our design. Finally, Section IV concludes this article and suggests directions for future research.

II. PROPOSED HARDWARE ARCHITECTURE ON AES

A new hardware architecture of AES is proposed herein to minimize hardware area based on shared hardware

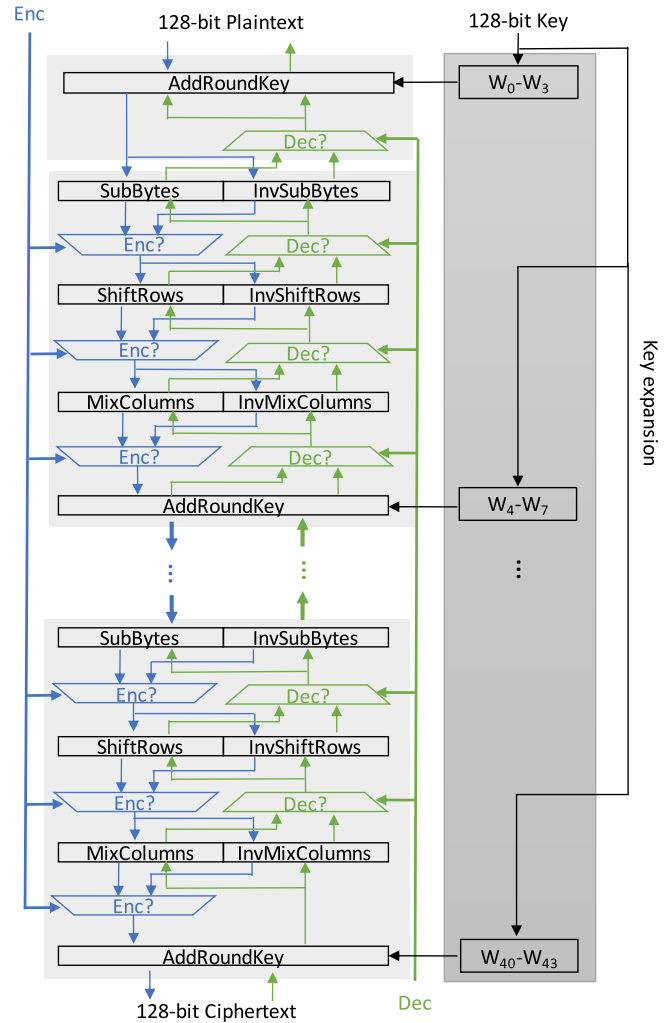


Fig. 1. Computation flow of AES in blocks.

resources among different computation sub-blocks, including SubBytes, ShiftRows, MixColumns, AddRoundKey, and KeyExpansion for encryption, while Inverse SubBytes, Inverse ShiftRows, Inverse MixColumns, AddRoundKey, and Inverse KeyExpansion for decryption. As illustrated in Fig. 1, the designed AES scheme proposed herein conducts forward and inverse operations simultaneously, as shown in black blocks, for encryption in blues and decryption in greens, respectively, and determining which operation result to use based on whether encryption or decryption is being performed. This approach helps reduce sensitivity between power and computation of AES, thereby enhancing defense ability of AES against power attacks. Furthermore, toward the minimized chip area, all the multiplications involved in the afore-mentioned sub-blocks of SubBytes and Inverse SubBytes are carried out in a composite field instead of storing the S-box in memory for the computation. On the other hand, the MixColumns and Inverse MixColumns are conducted by smaller matrix multipliers. In addition, the proposed AES adopts a dynamic key scheduling architecture for KeyExpansion and Inverse KeyExpansion to reduce hardware resources, eliminating the need to generate key storage in memory for each round operation. Note that

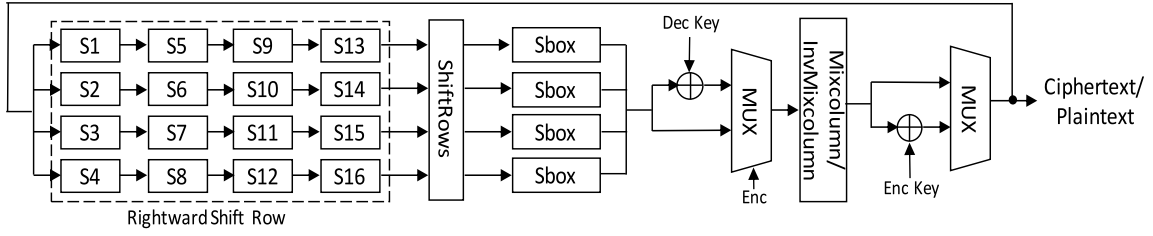


Fig. 2. Architecture of the proposed 32-bit datapath for AES.

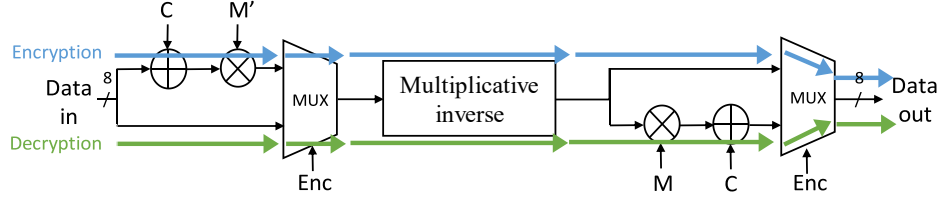


Fig. 3. Computation of SubBytes and Inverse SubBytes in circuit blocks.

in this way of design, no multiplexer needed for selection between modes of encryption and decryption, and being able to provide efficient hardware resources for each mode, finally resulting in reduced overall hardware area. To achieve high throughput, the computation for 128-bit AES is subchanneled into four pipelines, with each pipeline handling computation for one row data of 32 bits. Each pipeline conducts the computation for each round by right-shifting the values in each row, while sequentially does SubBytes, MixColumns, and AddRoundKey operations, as depicted in Fig. 2. The entire encryption or decryption process requires a total of 44 clock cycles to complete.

A. SubBytes and Inverse SubBytes

The composite field arithmetic [2] is employed herein to carry out the computation of Sbox, which is more efficient in area than the traditional design as presented in [28] where a look-up table (LUT) is used to carry out SubBytes and InvSubBytes. The composite field arithmetic adopts

$$y = M * X^{-1} \oplus C \quad (1)$$

for the SubBytes module, while

$$x = (M' * (Y \oplus C))^{-1} \quad (2)$$

for the InvSubBytes module. Both modules of SubBytes and InvSubBytes share the same designed datapath for $GF(2^8)$ multiplicative inverse. In the proposed design, for encryption, both multiplexers select the calculation results from the lower path as seen in Fig. 3, which are the sequence of performing the inverse affine transform, followed by the multiplicative inverse. Conversely, during decryption, both multiplexers select the calculation results from the upper path in Fig. 3, corresponding to the sequence of first performing the multiplicative inverse and then applying the affine transform for SubBytes. Also noted in Fig. 3 are the muxes accepting “1” or “0” for switching between the datapaths for encryption or decryption, respectively, as seen in blues or greens in Fig. 1.

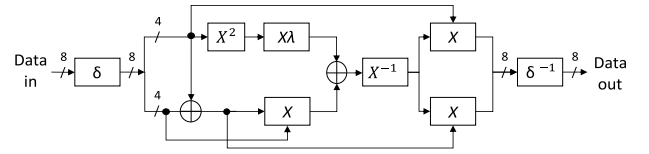


Fig. 4. Computation of multiplicative inverse in blocks.

The muxes designed herein facilitate the always-on operations of encryption and decryption in the designed AES.

The designed AES mathematical operation for multiplicative inverse is mainly on bytes, and uses the calculation method of finite field $GF(2^8)$, where GF represents as Galois Field. Both addition and multiplication are conducted in $GF(2^8)$. This work implements the $GF(2^8)$ multiplicative inverse method where $GF(2^8)$ is converted to $GF(2^4)^2$ for reducing the complexity of the hardware, and the irreducible polynomials [29] to decompose $GF(2^8)$ to $GF(2^4)^2$, i.e.,

$$GF(2^4)^2 : P(X) = X^4 + X + 1 \quad (3)$$

and

$$GF\left(\left(2^4\right)^2\right) : Q(X) = X^2 + X + \lambda \quad (4)$$

where λ is $\{1001\}_2$. The structure of multiplicative inverse is shown in Fig. 4, where δ means isomorphic to $GF(2^4)$, X does the multiplication operation in $GF(2^8)$, and $X * \lambda$ is the multiplication with constant λ in $GF(2^4)$. The operations of each block in the multiplicative inverse can be presented in terms of bits. The isomorphic mapping is employed to convert the $GF(2^8)$ to $GF((2^4)^2)$, while the inverse isomorphic mapping does $GF((2^4)^2)$ back to $GF(2^8)$. A new operation for multiplicative inversion in $GF(2^4)$ is in fact proposed herein by this study, which uses the Karnaugh map to reduce logic gates to AND, OR, and inverting gates, instead of using XOR only. In this way, $GF(2^8)$ can be converted into $GF((2^4)^2)$. This optimization results in a reduction in gate count from 392 to 352, leading to a more efficient design in terms of area. The

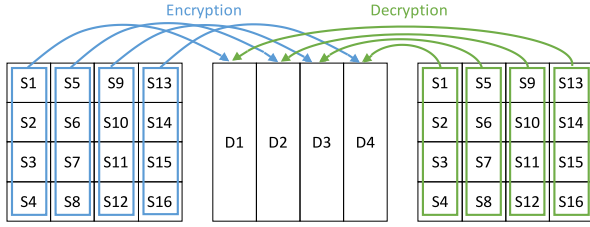


Fig. 5. Proposed method for Shiftrows and Inverse Shiftrows.

computation via $GF(2^4)^2$ is synthesized toward a good balance between chip area and latency.

For the Inverse SubByte computation, the approach of the Multiplicative Inverse with logic reduction is engineered, which allows to share a common circuit unit for multiple inverse multiplications to achieve minimal area. As a result, the area of the S-box is reduced approximately by 10% as compared to the Multiplicative Inverse without the logic reduction method applied. Furthermore, a 32-bit datapath operating simultaneously by 4 S-boxes is designed to carry out both 8-bit conversions of SubBytes and Inverse SubBytes. This design is aimed for enhancing the resistance against attacks that relies on exploiting the correlation between data and power traces. Thus, it is difficult now for attacks to separate measured power to those due to SubBytes and Inverse SubBytes, enhancing security greatly.

B. Shiftrows and Inverse Shiftrows

A novel data storage approach for implementing ShiftRows and inverse ShiftRows is engineered by this work. Fig. 5, illustrates the architecture of this new data storage approach. The 128-bit data is divided into four 32-bit blocks to store, where the encrypted data is stored in blocks D1–D4, while the decrypted data is stored in reverse order, from D4 to D1. Notably, there are MUXes to control how the row data is stored, as seen in blues and greens in Fig. 1 for encryption and decryption, respectively. By adopting this approach, the same results can be obtained using only the ShiftRows operation, regardless of whether the data is encrypted or decrypted. This work effectively reduces the area by 54.5% by sharing hardware between Shiftrows and inverse Shiftrows, compared to designing them separately.

C. Mix Columns and Inverse MixColumns

The Inverse MixColumns operation is decomposed into a matrix multiplication between the MixColumns matrix and a decomposition matrix, which is

$$\begin{bmatrix} 0xe & 0xb & 0xd & 0x9 \\ 0x9 & 0xe & 0xb & 0xd \\ 0xd & 0x9 & 0xe & 0xb \\ 0xb & 0xd & 0x9 & 0xe \end{bmatrix} = \begin{bmatrix} 0x2 & 0x3 & 0x1 & 0x1 \\ 0x1 & 0x2 & 0x3 & 0x1 \\ 0x1 & 0x1 & 0x2 & 0x3 \\ 0x3 & 0x2 & 0x1 & 0x1 \end{bmatrix} \times \begin{bmatrix} 0x5 & 0x4 & 0x0 & 0x0 \\ 0x0 & 0x5 & 0x4 & 0x0 \\ 0x0 & 0x0 & 0x5 & 0x4 \\ 0x4 & 0x0 & 0x0 & 0x5 \end{bmatrix}. \quad (5)$$

As illustrated in Fig. 6, each column's four elements are inputs into the matrix multiplication using the variables a0 to a1 shown in the figure. The operation is conducted for either encryption or decryption according to the selection by a multiplexer. For encryption operation, only the matrix multiplication of the MixColumn matrix following the multiplexer is conducted. As for decryptions, the matrix multiplication with the decomposition matrix is finished first prior to the matrix multiplication of the MixColumn matrix. This approach achieves a gate-level area of 352 gate count and a gate-level delay of 1.31 ns, with the operations of encryption and decryption sharing the same circuit for matrix multiplication of the MixColumn matrix. In comparison, the alternative method, which uses a separate MixColumns matrix and two different decomposition matrices for matrix addition, results in a 10.4% larger area and a 9.1% longer delay.

D. Key Expansion

The key expansion process in the AES algorithm is responsible for deriving the round keys from the initial key. In the 32-bit AES architecture, the first step, SubWord, involves parallel input of four S-boxes, with each S-box being applied for four times. The second step, RotWord, performs byte displacement using hardware connections. The third step, Rcon, utilizes an on-the-fly key architecture that directly interacts with AddRoundKey, eliminating the need for additional memory to store the keys generated in each round for Rcon operations. This work introduces a new design to implement Rcon without the need for additional triggers, as illustrated in Fig. 7(a). This method employs logical functions to calculate the new value of Rcon based on the current Rcon, while multiplexers are utilized to select the Rcon value for either encryption or decryption, resulting in a gate-level area of only 46 Gate count. This approach reduces the area by 50.5% compared to using Xtime logical functions and by 61.7% compared to the traditional LUT-based method. Toward high throughput, the proposed 32-bit AES key expansion architecture operates on 32 bits with four S-boxes within a single clock cycle, as illustrated in Fig. 7(b). Note that this design incorporates right-shifting registers, as shown in Fig. 2, to facilitate AES pipelining, then allowing for the computation of round key in each cycle to avoid the immediate complete expansion of the key, finally easing the requirement of additional storage capacity.

E. Countermeasure Effect on Power Attack

It is pertinent to note herein that both forward and inverse operations for encryption and decryption, respectively, are executed simultaneously for all the tasks, even for each time of operation, it could be for most of times only encryption to decryption being requested. This proposed both-on computation of encryption and decryption pose extreme difficulty for attackers to identify points of interests, let alone to extract keys based on power analysis. In each computational stage, the needed subcircuits are selected from the results of both operations, to conduct both encryption and decryption. This designed architecture of AES with both encryption and

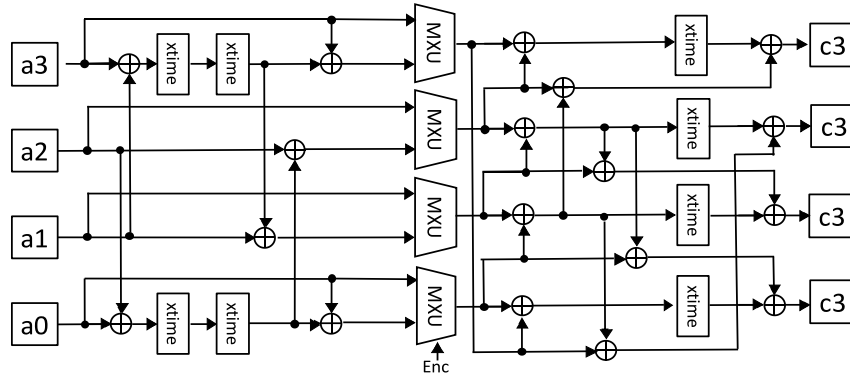


Fig. 6. 32-bit matrix multiplication for MixColumns and Inverse MixColumn.

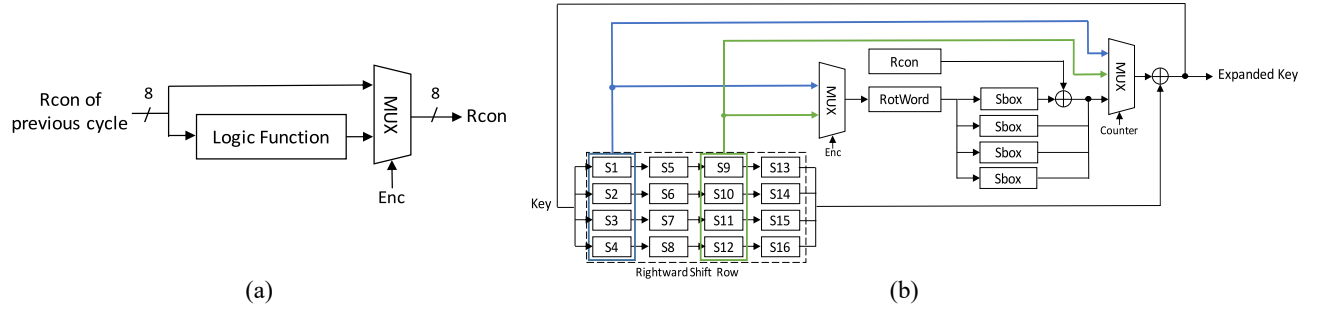


Fig. 7. Computation of (a) Rcon with logic function and (b) proposed key expansion for AES in circuit blocks.

decryption on surely increases power consumption during computation, but it does not significantly raise power consumption due to designed lightweight features of composite field algorithm matrix multiplication for Mix/InvMix-Columns and novel ShiftRow/Inverse-ShiftRow operations. Actually, our design is still quite competitive to the leading group of reported works in power consumption in terms of energy/bit, which will be discussed and evidenced in Section III-D. Furthermore, this computational approach makes it very difficult for attackers to identify points of interests through power analysis, let alone triggering significant circuit branches by determining whether encryption or decryption is being performed, thereby increasing significantly the security level of the designed AES chip.

III. EXPERIMENTAL RESULTS

The afore-proposed AES architecture designed with high throughput-to-area efficiency and strong resilience to attacks is implemented by this study for performance validation.

A. Implementing AES in an FPGA Board

An experimental hardware system as shown in Fig. 8 was built to validate the performance of the proposed AES architecture. The hardware comprises a field programmable gate array (FPGA) board for implementing AES and a mode control unit based on electronic codebook (ECB) [30] to manage input/output data in real time. The plaintext to be encrypted is segmented in blocks via ECB for encryption [31]. To the end of implementing the afore-proposed AES, the designed 32-bit datapath of AES, including SubBytes, ShiftRows,

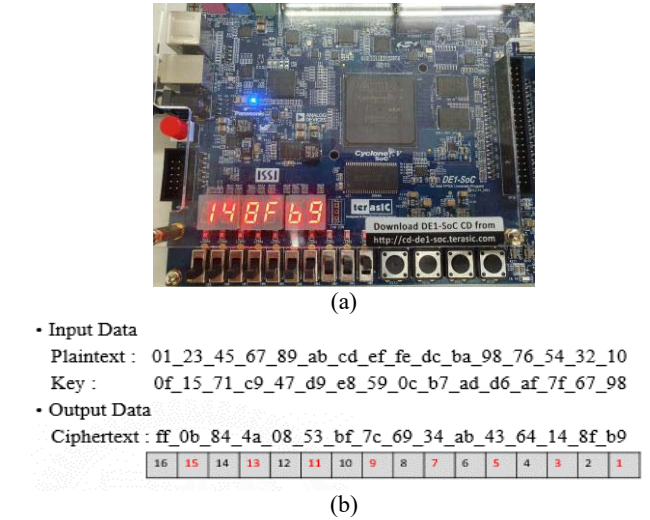


Fig. 8. (a) Displayed output data in 16-bit values on the FPGA board. (b) Example of plaintext and correct cyphertext.

MixColumns, AddRoundKey and KeyExpansion, and their inverse counterparts are synthesized via Verilog and further burnt in to an FPGA board for experiment. Two sets of 128-bit shift registers are synthesized to, respectively, store input plaintexts and other intermediate computed data, as well as keys.

To conduct physical verification of the designed AES circuit using FPGA, this work used first memory to store test signals and data in the test bench and then compare the post-simulation results of the FPGA with the register-transfer level

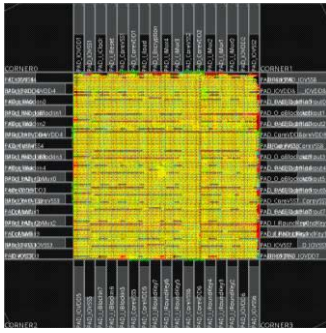


Fig. 9. Chip layout of the designed 32-bit AES datapath.

(RTL) simulation results. The initial value of the test data in memory is the input data of the RTL simulation. When the reset signal is activated, data is input to the AES, while the output is displayed on the seven-segment display. The RTL code for the proposed AES is implemented on a Quartus FPGA board. There are six switch buttons to control the output of the FPGA seven-segment display as shown in Fig. 8(a), with the operation results in Fig. 8(b). It has been verified that the ciphertext given by the FPGA is the same with the output result of ModelSim, indicating that the proposed AES algorithm also works correctly for both encryption and decryption in the FPGA board.

B. Chip Implementation and Performance Achieved

The AES chip of encryption and decryption is designed for processing 32-bit data with minimal gate count. The user input interface includes control pins such as encryption/decryption selection, data input and data output selection. The overall architecture consists of the round unit, the Control Unit, the Key Expansion, and the Data Register Unit. The inputs interface includes control pins such as the 1-bit encryption/decryption mode selection, 1-bit data input, 1-bit key input, 1-bit initial vector for reset, 1-bit data output, and the 1-bit output ready signal. All inputs and outputs of the AES designed are integrated into a chip. For synthesization, the Genus synthesis software by Cadence were utilized to implement the designed AES into an FPGA board and further to form a chip. The designed AES architecture was simulated at RTL level using ModelSim to verify the performance of the designed datapath. The RTLs are converted into a gate-level circuit using the TSMC 40-nm Cell-Library to generate timing-delay and netlist files. The simulation results in ModelSim indicate that the proposed AES core can operate at a clock frequency of up to 238.10 MHz without any timing violation. The proposed AES architecture have a gate count of 5.65k and a throughput of 692.65 million bits per second, with a chip area of 13 340 μm^2 .

Fig. 9 shows the designed layout of the AES encryption and decryption chip. The core operation part in the layout in Fig. 10 contains the round unit and key expansion. There is a control unit that regulates the core's internal processes in response to external control signals. The datapaths of the round units designed are in 32 or 8 bit, while the input and output pins of the chip are in 8 bits. Note that the serial data

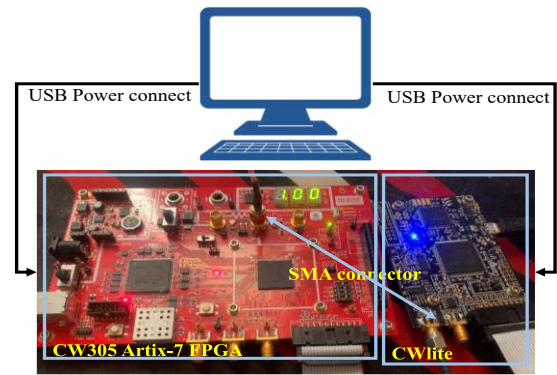


Fig. 10. Experimental setup.

were converted in parallel to the round unit for computation, while the data is output serially again once the computations are completed. This work used Synopsys Innovus software for automatic places and routes. While automatic places and routes are finished, the DRC and LVS were conducted for verification. Fig. 10 shows the 32-bit chip layout with a core area of 13 340 μm^2 . The chip has 68 pins. Among them, eight groups of internal power supplies are used for the chip, while other seven groups of external power supplies are used for I/O pads.

C. Performance Against Attacks

The hardware platform implementing the differential power analysis (DPA) for attacks is shown in Fig. 10. Seen in the photograph in this figure are a red FPGA board CW305 at left with AES implemented inside and under attacks, while another black board CWlite at right as the target board to generate power glitches on CW305. Power traces collected during the process of simultaneous encryption and decryption are captured and analyzed on computer for key guessing. In fact, in order to validate the security of the proposed AES, another unprotected 128-bit AES datapath was also synthesized and implemented in the CW305 board along with the proposed AES in the board for performance comparison in terms of resilience to correlation power attack.

Partial guessing entropy (PGE) is employed as a metric for assessing algorithm security, actually quantifying the number of missing bits before key guessing succeeds. The results are shown in Fig. 11. Evidenced from these figures, the PGE values of the unprotected AES do converge close to zero while the proposed AES does not, as seen clearly from Fig. 11(a) versus (d). Also seen from Fig. 11(b) and (e) are the correlations converged to nonzeros between measured power traces and guessed keys in Fig. 11(b) by the unprotected AES, while to zeros in Fig. 11(e) by the proposed AES datapath. It indicates that the unprotected AES was attacked successfully, while the proposed AES was not, even with 10 000 traces collected. Finally, seen in Fig. 11(c) are significantly high correlations between sample nos. 44 and 47 in traces, indicating a found point of interests enabling effective attacks, while a point of interests cannot be found at all with the proposed AES as seen clearly in Fig. 11(f) where there is no peak standing

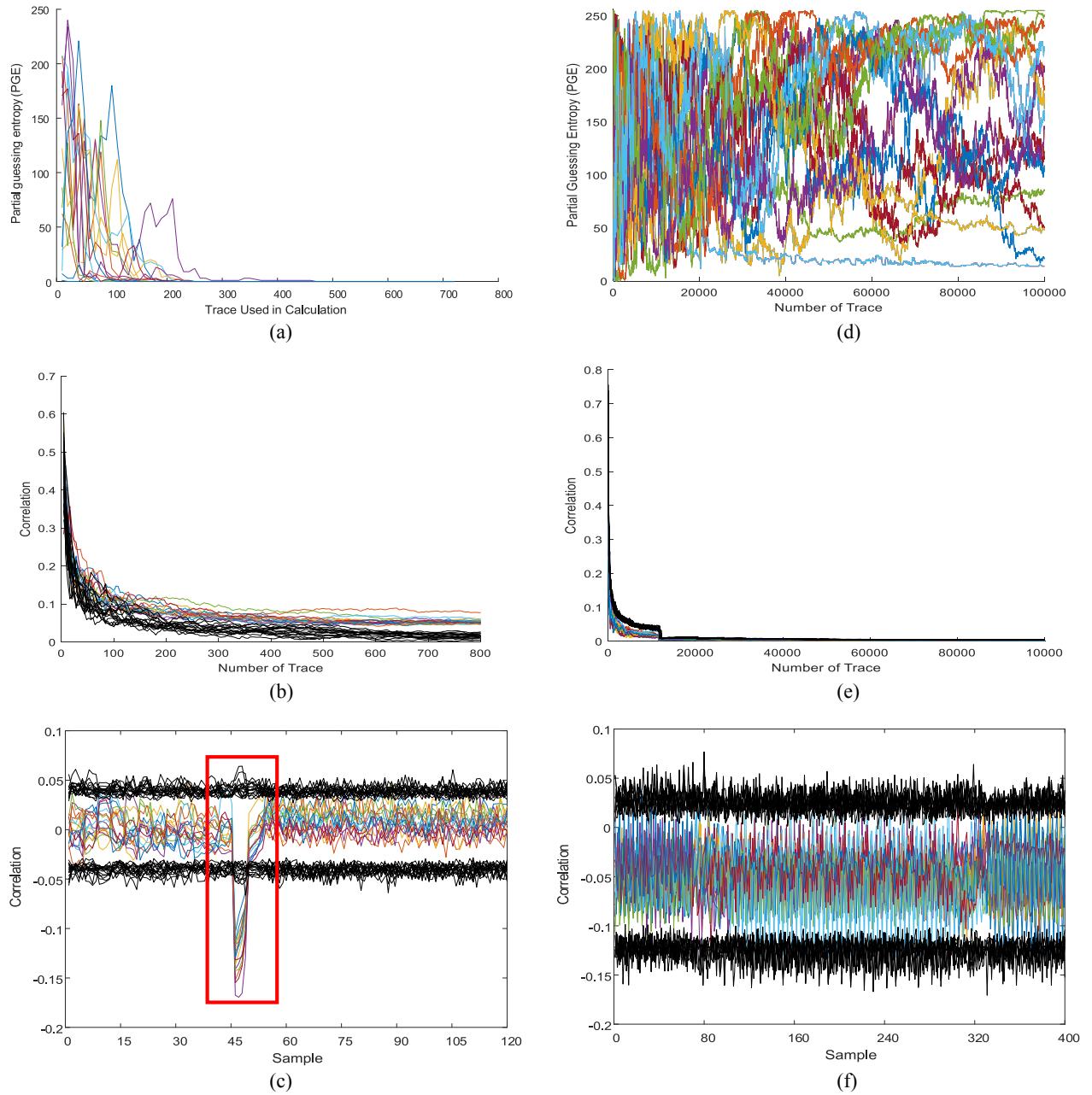


Fig. 11. (a) PGE versus No. of Traces, (b) Correlation versus No. of Traces and (c) Correlation versus Samples by a typical, unprotected AES; (d) PGE versus No. of Traces, (e) Correlation versus No. of Traces, and (f) Correlation versus Samples for the proposed, protected AES.

out of the other correlations, in other words, no chance for successful power attacks. The resilience to attacks shown herein attributes to mixed, parallel computation of encryption and decryption in the AES proposed by this work. In fact, the unprotected AES did surrender to key guessing within 800 power traces with the PGE trend in Fig. 11(a) showing a declining pattern, while the proposed AES showed strong resilience against power attacks even with detecting traces exceeding 100 000, where as seen in Fig. 11(e) the correlation remains zero, still not attacked successfully. The success herein is owing to the extreme difficulty for attacks to separate measured sum power to those due to SubBytes and Inverse SubBytes, enhancing security greatly; in other words, the correlation between power and keys is averaged out from those

by SubBytes and Inverse SubBytes before being viciously attacked.

D. Performance Comparison With Others

Performance comparison between the proposed lightweight AES and other prior arts are presented herein via Table I and Fig. 12. Table I provides a comprehensive comparison of performance by the proposed AES and all the related prior works in terms of area, power consumption, throughput, and an FOM defined as throughput divided by area in (Mb/s/k-gate), while Fig. 12 presents the performances from the perspective of FOM versus “energy per bit.” Note that in Table I the present work offers two different versions of performance,

TABLE I
PERFORMANCE COMPARISON AMONG THE PROPOSED AND OTHER REPORTED 128-BIT AES DATAPATHS

	Datapath	Board / Tech (nm)	Energy (pJ/bit)	Frequency (MHz)	Clock Cycle	Throughput (Mbps)	Gate count ¹ (k-gates)	FOM (Mbps/k-gate)
Satoh <i>et al.</i> in 2001 [4]	32	110	-	137	44	398.55	6.3	63.26
Pramstaller <i>et al.</i> in 2004 [5]	32	60	-	50	92	69.57	8.54	8.15
Mathew <i>et al.</i> in 2011 [6]	2-stage pipeline	45	0.511	255	20	1632	100	16.32
Pham <i>et al.</i> in 2012 [7]	128	Cyclone II	5.84	78.39	160	28.5	1.108	25.72
Wang <i>et al.</i> in 2013 [12]	128	Virtex-6	-	14.69	1	1880	182.60	10.30
Banik <i>et al.</i> in 2015 [8]	32	90	6.2	10	46	27.83	5.5	5.06
Mathew <i>et al.</i> in 2015 [9]	8	22	3.9	1113	336	432	4.04	106.93
Kouser <i>et al.</i> in 2016 [13]	128	Spartan-6	-	239.96	41	749.14	68.33	10.96
Bui <i>et al.</i> in 2016 [10]	64	65	3.54	10	37	16.5	2.11	7.82
Bui <i>et al.</i> in 2017 [21]	32	28	0.65-0.8	10	44	29.09	8.6	3.38
Kim <i>et al.</i> in 2019 [22]	32	65	0.78	10	186	6.88	5.4	1.27
Jain <i>et al.</i> in 2019 [14]	128	Artix-7	-	273.29	44	795.03	16.12	49.32
Dong <i>et al.</i> in 2019 [24]	128	45	0.51	870	11	10123	164.5	61.54
Ruby <i>et al.</i> in 2020 [11]	128	Virtex-7	-	0.258	129	33.07	6.50	5.09
Pandey <i>et al.</i> in 2020 [15]	128	180	4.42	200	73	289.34	53	5.46
Lata <i>et al.</i> in 2020 [16]	8	Spartan-6	-	272.33	-	3485	59.20	58.87
Kundi <i>et al.</i> in 2020 [26]	32	Virtex-6	4.32	332.98	20	1856	37.80	49.10
Chong <i>et al.</i> in 2021 [25]	128	Kintex-7	0.23	12	10	153.6	17	9.04
Scripcariu <i>et al.</i> in 2021 [17]	128	Virtex-6	-	60.02	10	700	25.468	9.04
Gunasekaran <i>et al.</i> in 2021 [18]	32	Virtex-7	4.3	161	74	278.49	13.70	20.33
Davis <i>et al.</i> in 2022 [23]	32	90	0.66	20	61	41.97	0.83	27.49
Lee <i>et al.</i> in 2022 [19]	32	Kintex-7	-	333	-	805	5.18	50.87
Lee <i>et al.</i> in 2022 [20]	32	16	-	526	94	716.26	8.55	83.77
Ng <i>et al.</i> in 2022 [27]	128	Kintex-7	7.10	22	11	256	2.57 ²	99.61
The proposed chip	32	Kintex-7	2.97	166.49	44	493.06	5.34	92.33
	32	40	1.16	238.10	44	692.65	5.65	122.59

¹ The gate counts extracted from each of the prior works may vary, depending on the respective baseline designs.

² Converted from the number of slices without LUTs and FFs.

by the Kintex-7 FPGA board and the TSMC 40-nm process. Note also that the column regarding energy consumptions in pJ/bit by the present work and all the prior arts are estimated in adequate precision by the design and verification tool of the FPGA board and that of the adopted process, to arrive at fair performance evaluation and comparison. A quick analysis on Table I reveals that Davis and John [23] presented the smallest AES in 2022, utilizing a mere 0.83K gate count. Chong et al. [25] achieved the lowest energy consumption with

their AES, demonstrating an energy per bit of only 0.23 pJ/bit. Different from these studies, this work not only emphasizes area and power consumption but also aiming for a meaningful balance among area, power consumption, and throughput for IoT devices, as aimed also by Kundi et al. [26]. The degree of this balance can be quantified by an FOM as (Mbps/k-gates), i.e., the throughput over area. It evidenced from Table I and Fig. 12 that the proposed AES synthesized by the TSMC 40-nm process stands out of all the others synthesized by

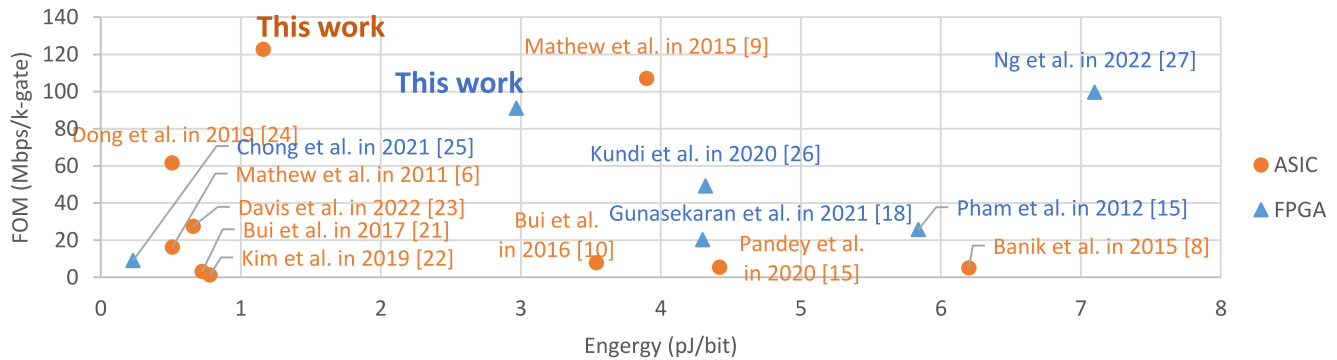


Fig. 12. Comparison of FOM versus energy per bit among AESes.

either some FPGA boards or processes, as the best with the highest FOM as 122.59 Mb/s/k-gate, and very small area of 5.65 k-gates while comparatively lower power in energy per bit, underscoring its exceptional performance. Focusing on the performances only by FPGA boards, this work implemented in Kintex-7 shows also excellent performance, second only to that by Ng et al. [27]. However, the AES datapath by Ng et al. [27] was successfully attacked within 5000 power traces, as opposed to more than 100 000 required for the AES proposed by this study, thanks to the unique design of mixed, parallel computation of encryption and decryption in this proposed AES, as detailed in Section III-C. In addition, the proposed AES achieves 193% more in throughput and a 42% further reduction in energy per bit as compared to [27].

IV. CONCLUSION

A novel low-cost lightweight AES is proposed by this effort, optimized successfully with high efficiency for lightweight applications in IoT devices. The proposed AES architecture is designed for 32-bit encryption in parallel for the 128-bit AES to reduce hardware area. The optimization is achieved via using shift registers instead of plain registers in the operation stage of ShiftRows to optimize the 32-bit datapath AES, ShiftRows, MixColumns, and key expansion. This work was implemented on an Intel Altera FPGA board and by the TSMC 40-nm Cell-Library, achieving a throughput of 692.65 Mb/s, a gate count of 5.65K, and a FOM defined as the ratio of throughput to area of 122.59 Mb/s/k-gate, with a chip area of 13340 μm^2 , which is the best over all the reported works. As for security evaluation, the proposed AES with both computations of encryption and decryption on safeguards successfully the correlation power analysis attacks even with 100 000 traces collected.

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